

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2655902

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
LISA M ALBAUGH		12/18/2013
DAVID A SMITH		12/18/2013
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State/Country:	MICHIGAN	
Postal Code:	48265-3000	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14135018	
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Date:	12/19/2013	
Total Attachments: 1 source=Assignment_P026917#page1.tif		

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PATENT

**ASSIGNMENT**

Pursuant to an agreement with my employer, I formally assign to GM GLOBAL TECHNOLOGY OPERATIONS LLC, the entire right, title and interest, in all countries and application types, in the improvements set forth in the United States patent application P026917-PTUS-CHE entitled

Thick Film Circuits with Conductive Components Formed Using Different  
Conductive Elements and Related Methods

for which I executed a declaration. If the patent application has been filed, I authorize any practitioner associated with Customer No. 106681 to insert the application number and filing date of said application here in parentheses (14/135,018 filed Dec. 19, 2013) when known.

Inventor's signature

Lisa M Albaugh

Date 18 December 2013

Full name :

LISA M ALBAUGH

Residence :

FRANKFORT, INDIANA

Inventor's signature

David A Smith

Date 18-DEC-13

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